

Mechanical Specifications

Wireless HSDPA-/UMTS-Modems

This whitepaper describes the mechanical specifications of the following products:

- LyconSys 3G+1 HSDPA
- LyconSys 3G+2 HSUPA
- LyconSys 3G+3 HSUPA/GPS

Physical Dimensions and Weight

Dimensions: 35 x 86 x 58 mm (W x H x T)*

*Add 10mm to height for the power plug.

Weight: 98 gram

Durability against Environmental Conditions

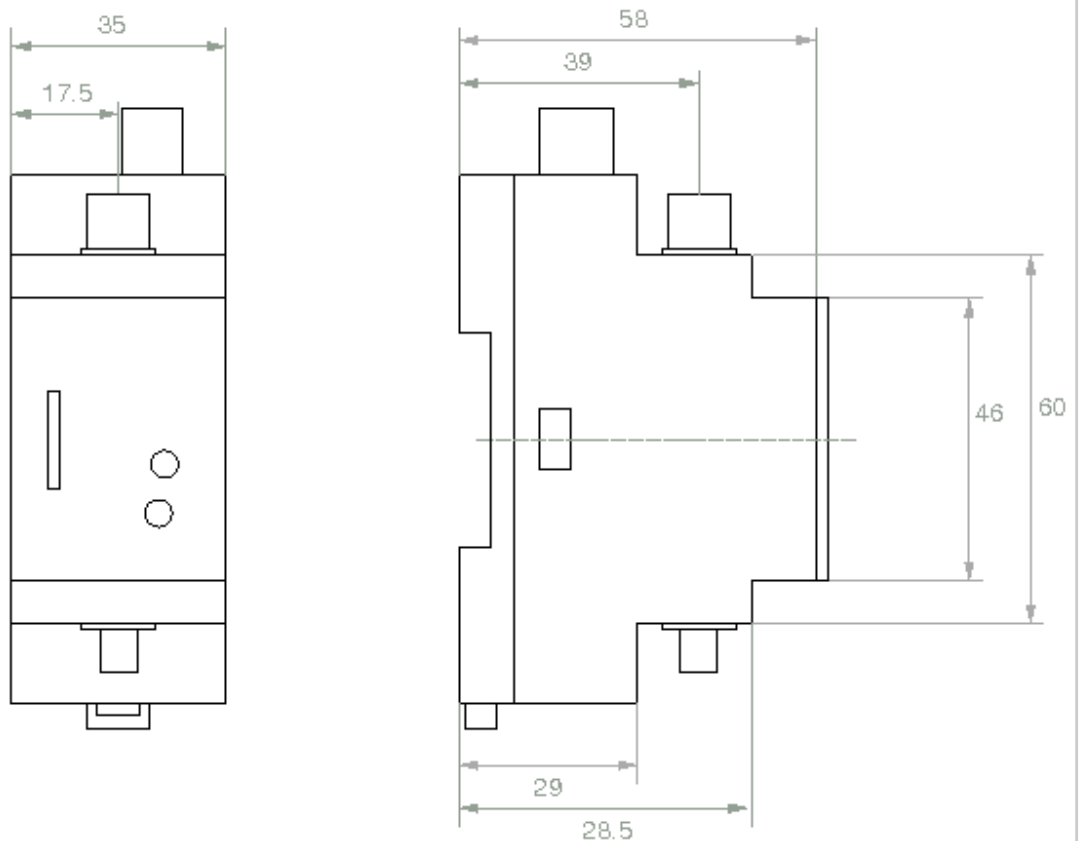
The modems are designed for operating temperatures in range of -20°C to +60°C in a non-condensing environment. The Safety Class is IP30.

SIM card slot and RESET button are protected against dust by a removeable dust-cover.

Mounting

The modems can be mounted on standard 35mm DIN-rails. Additional outlets for wall-mounting are available as an option.

Housing Drawings



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